

## MM74HC174 — Hex D-Type Flip-Flops with Clear

### Features


- Typical Propagation Delay: 16ns
- Wide Operating Voltage Range: 2V–6V
- Low Input Current: 1μA maximum
- Low Quiescent Current: 80μA (74HC Series)
- Output Drive: 10 LSTTL Loads

### Description

The MM74HC174 edge-triggered flip-flops utilize silicon-gate CMOS technology to implement D-type flip-flops. They possess high noise immunity, low-power, and speeds comparable to low-power Schottky TTL circuits. This device contains six master-slave flip-flops with a common clock and common clear. Data on the D input with the specified setup and hold times is transferred to the Q output on the LOW-to-HIGH transition of the CLOCK input. When LOW, the input sets all outputs to a LOW state.

Each output can drive ten low-power Schottky TTL equivalent loads. The MM74HC174 is functionally and pin comparable to the 74LS174. All inputs are protected from damage due to static discharge by diodes to V<sub>CC</sub> and ground.

### Ordering Information

| Part Number   | Operating Temperature Range |  Eco Status | Package  | Packing Method |
|---------------|-----------------------------|--|--|----------------|
| MM74HC174M    | -40 to +85°C                | RoHS   | 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Inch Narrow | Tubes          |
| MM74HC174MX   | -40 to +85°C                |  |  | Tape and Reel  |
| MM74HC174MTC  | -40 to +85°C                | RoHS   | 16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide      | Tubes          |
| MM74HC174MTCX | -40 to +85°C                |  |  | Tape and Reel  |
| MM74HC174N    | -40 to +85°C                | RoHS   | 16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Inch Wide       | Tubes          |

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### Pin Configuration

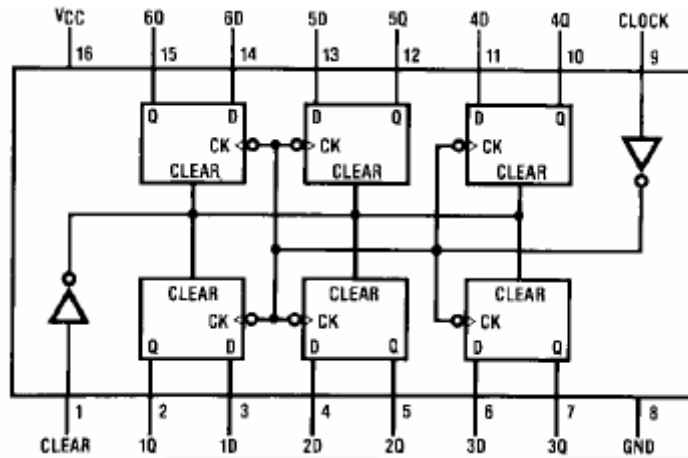


Figure 1. Pin Configuration (Top View)

### Truth Table (Each Flip-Flop)

| Inputs |                  |            | Output                        |
|--------|------------------|------------|-------------------------------|
| Clear  | Clock            | D          | Q                             |
| LOW    | Don't Care       | Don't Care | LOW                           |
| HIGH   | ↑ <sup>(1)</sup> | HIGH       | HIGH                          |
| HIGH   | ↑ <sup>(1)</sup> | LOW        | LOW                           |
| HIGH   | LOW              | Don't Care | Q <sub>0</sub> <sup>(2)</sup> |

**Notes:**

1. Transition from LOW to HIGH level.
2. The level of Q before the indicated steady-state input conditions were established.

### Logic Diagram

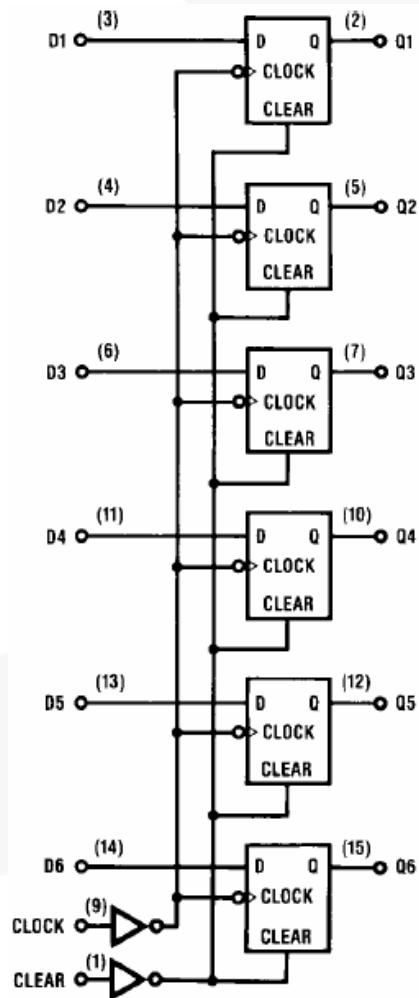


Figure 2. Logic Diagram

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Unless otherwise noted, all voltages are referenced to ground.

| Symbol           | Parameter                              | Min.             | Max.     | Unit               |
|------------------|--|------------------|----------|--------------------|
| $V_{CC}$         | Supply Voltage                         | -0.5             | +7.0     | V                  |
| $V_{IN}$         | DC Input Voltage                       | -1.5 to $V_{CC}$ | +1.5     | V                  |
| $V_{OUT}$        | DC Output Voltage                      | -0.5 to $V_{CC}$ | +0.5     | V                  |
| $I_{IK}, I_{OK}$ | Clamp Diode Current                    |                  | $\pm 20$ | mA                 |
| $I_{OUT}$        | DC Output Current, per Pin             |                  | $\pm 25$ | mA                 |
| $I_{CC}$         | DC $V_{CC}$ or GND Current, per Pin    |                  | $\pm 50$ | mA                 |
| $T_{STG}$        | Storage Temperature Range              | -65              | +150     | $^{\circ}\text{C}$ |
| $P_D$            | Power Dissipation <sup>(3)</sup>       | TSSOP, PDIP      | 600      | mW                 |
|                  |  | SOIC             | 500      |                    |
| $T_L$            | Lead Temperature, Soldering 10 Seconds |                  | 260      | $^{\circ}\text{C}$ |

### Notes:

- Power dissipation temperature derating— plastic “N” package: 12mW/ $^{\circ}\text{C}$  from 65 $^{\circ}$  to 85 $^{\circ}\text{C}$ .

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol            | Parameter                   | Conditions           | Min. | Max.     | Unit               |
|-------------------|-----------------------------|----------------------|------|----------|--------------------|
| $V_{CC}$          | Supply Voltage              |                      | 2    | 6        | V                  |
| $V_{IN}, V_{OUT}$ | DC Input or Output Voltage  |                      | 0    | $V_{CC}$ | V                  |
| $T_A$             | Operating Temperature Range |                      | -40  | +85      | $^{\circ}\text{C}$ |
| $t_r, t_f$        | Input Rise and Fall Times   | $V_{CC}=2.0\text{V}$ |      | 1000     | ns                 |
|                   |                             | $V_{CC}=4.5\text{V}$ |      | 500      | ns                 |
|                   |                             | $V_{CC}=6.0\text{V}$ |      | 400      | ns                 |

DC Electrical Characteristics<sup>(4)</sup>

| Symbol          | Parameter                         | Conditions   | V <sub>CC</sub><br>(V) | T <sub>A</sub> =25°C |                   |      | T <sub>A</sub> =-40<br>to+85°C | T <sub>A</sub> =-55<br>to<br>+125°C | Units |
|-----------------|-----------------------------------|--|------------------------|----------------------|-------------------|------|--------------------------------|-------------------------------------|-------|
|                 |                                   |  |                        | Typ.                 | Guaranteed Limits |      |                                |                                     |       |
| V <sub>IH</sub> | Minimum HIGH Level Input          |  | 2.0                    |                      | 1.5               | 1.5  | 1.5                            | V                                   |       |
|                 |                                   |  | 4.5                    |                      | 3.15              | 3.15 | 3.15                           |                                     |       |
|                 |                                   |  | 6.0                    |                      | 4.2               | 4.2  | 4.2                            |                                     |       |
| V <sub>IL</sub> | Minimum LOW Level Input           |  | 2.0                    |                      | 0.5               | 0.5  | 0.5                            | V                                   |       |
|                 |                                   |  | 4.5                    |                      | 1.35              | 1.35 | 1.35                           |                                     |       |
|                 |                                   |  | 6.0                    |                      | 1.8               | 1.8  | 1.8                            |                                     |       |
| V <sub>OH</sub> | Minimum HIGH Level Output Voltage | V <sub>IN</sub> =V <sub>IH</sub> or<br>V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 20μA  | 2.0                    | 2.0                  | 1.9               | 1.9  | 1.9                            | V                                   |       |
|                 |                                   |  | 4.5                    | 4.5                  | 4.4               | 4.4  | 4.4                            |                                     |       |
|                 |                                   |  | 6.0                    | 6.0                  | 5.9               | 5.9  | 5.9                            |                                     |       |
| V <sub>OH</sub> | Minimum HIGH Level Output Voltage | V <sub>IN</sub> =V <sub>IH</sub> or<br>V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 4.0mA | 4.5                    | 4.20                 | 3.98              | 3.84 | 3.70                           | V                                   |       |
|                 |                                   |  | 6.0                    | 5.70                 | 5.48              | 5.34 | 5.20                           |                                     |       |
|                 |                                   |  | 6.0                    | 5.70                 | 5.48              | 5.34 | 5.20                           |                                     |       |
| V <sub>OL</sub> | Minimum LOW Level Output Voltage  | V <sub>IN</sub> =V <sub>IH</sub> or<br>V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 20μA  | 2.0                    | 0                    | 0.1               | 0.1  | 0.1                            | V                                   |       |
|                 |                                   |  | 4.5                    | 0                    | 0.1               | 0.1  | 0.1                            |                                     |       |
|                 |                                   |  | 6.0                    | 0                    | 0.1               | 0.1  | 0.1                            |                                     |       |
| V <sub>OL</sub> | Minimum LOW Level Output Voltage  | V <sub>IN</sub> =V <sub>IH</sub> or<br>V <sub>IL</sub> ,  I <sub>OUT</sub>   ≤ 4.0mA | 4.5                    | 0.2                  | 0.26              | 0.33 | 0.40                           | V                                   |       |
|                 |                                   |  | 6.0                    | 0.20                 | 0.26              | 0.33 | 0.40                           |                                     |       |
|                 |                                   |  | 6.0                    | 0.20                 | 0.26              | 0.33 | 0.40                           |                                     |       |
| I <sub>IN</sub> | Maximum Input Current             | V <sub>IN</sub> =V <sub>CC</sub> or GND  | 6.0                    |                      | ±0.1              | ±1.0 | ±1.0                           | μA                                  |       |
| I <sub>CC</sub> | Maximum Quiescent Supply Current  | V <sub>IN</sub> =V <sub>CC</sub> or GND,<br>I <sub>OUT</sub> =0μA                    | 6.0                    |                      | 8                 | 80   | 160                            | μA                                  |       |

**Note:**

4. For a power supply of 5V ±10%, the worst-case output voltages (V<sub>OH</sub> and V<sub>OL</sub>) occur for HC at 4.5V. The 4.5V values should be used when designing with this supply. Worst-case V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5V and 4.5V, respectively. (The V<sub>IH</sub> value at 5.5V is 3.85V.) The worst-case leakage current (I<sub>IN</sub>, I<sub>CC</sub>, and I<sub>OZ</sub>) occurs for CMOS at the higher voltage, so the 6.0V values should be used.

**AC Electrical Characteristics**

$V_{CC} = 5V$ ,  $T_A = 25^\circ C$  and  $C_L = 15pF$ ,  $t_r = t_f = 6ns$ .

| Symbol             | Parameter  | Typ. | Guaranteed Limit | Unit |
|--------------------|--|------|------------------|------|
| $f_{MAX}$          | Maximum Operating Frequency                          | 50   | 30               | MHz  |
| $t_{PHL}, t_{PLH}$ | Maximum Propagation Delay, Clock, or Clear to Output | 16   | 30               | ns   |
| $t_{REM}$          | Minimum Removal Time, Clear to Clock                 | -2   | 5                | ns   |
| $t_S$              | Minimum Setup Time, Data to Clock                    | 10   | 20               | ns   |
| $t_H$              | Minimum Hold Time, Clock to Data                     | 0    | 5                | ns   |
| $t_W$              | Minimum Pulsewidth, Clock or Clear                   | 10   | 16               | ns   |

**AC Electrical Characteristics<sup>(5)</sup>**

$C_L = 50pF$ ,  $t_r = t_f = 6ns$  unless otherwise noted.

| Symbol             | Parameter  | $V_{CC}$ (V) | $T_A = 25^\circ C$ |                   | $T_A = -40$ | $T_A = -55$ to | Units |
|--------------------|--|--------------|--------------------|-------------------|-------------|----------------|-------|
|                    |  |              | Typ.               | Guaranteed Limits |             |                |       |
| $f_{MAX}$          | Maximum Operating Frequency                                | 2.0          |                    | 5                 | 4           | 3              | MHz   |
|                    |  | 4.5          |                    | 27                | 21          | 18             |       |
|                    |  | 6.0          |                    | 31                | 24          | 20             |       |
| $t_{PHL}, t_{PLH}$ | Maximum Propagation Delay, Clock, or Clear to Output       | 2.0          | 55                 | 165               | 206         | 248            | ns    |
|                    |  | 4.5          | 18                 | 33                | 41          | 49             |       |
|                    |  | 6.0          | 16                 | 28                | 35          | 42             |       |
| $t_{REM}$          | Minimum Setup Time, Data to Clock                          | 2.0          | 1                  | 5                 | 5           | 5              | ns    |
|                    |  | 4.5          | 1                  | 5                 | 5           | 5              |       |
|                    |  | 6.0          | 1                  | 5                 | 5           | 5              |       |
| $t_S$              | Minimum Setup Time, Data to Clock                          | 2.0          | 42                 | 100               | 125         | 150            | ns    |
|                    |  | 4.5          | 12                 | 20                | 25          | 30             |       |
|                    |  | 6.0          | 10                 | 17                | 21          | 25             |       |
| $t_H$              | Minimum Hold Time, Clock to Data                           | 2.0          | 1                  | 5                 | 5           | 5              | ns    |
|                    |  | 4.5          | 1                  | 5                 | 5           | 5              |       |
|                    |  | 6.0          | 1                  | 5                 | 5           | 5              |       |
| $t_W$              | Minimum Pulse Width, Clock or Clear                        | 2.0          | 35                 | 80                | 106         | 120            | ns    |
|                    |  | 4.5          | 10                 | 16                | 20          | 24             |       |
|                    |  | 6.0          | 8                  | 14                | 18          | 20             |       |
| $t_{TLH}, t_{THL}$ | Maximum Output Rise and Fall Time                          | 2.0          | 30                 | 75                | 95          | 110            | ns    |
|                    |  | 4.5          | 8                  | 15                | 19          | 22             |       |
|                    |  | 6.0          | 7                  | 13                | 16          | 19             |       |
| $t_r, t_f$         | Maximum Input Rise and Fall Time                           | 2.0          |                    | 1000              | 1000        | 1000           | ns    |
|                    |  | 4.5          |                    | 500               | 500         | 500            |       |
|                    |  | 6.0          |                    | 400               | 400         | 400            |       |
| $C_{PD}$           | Power Dissipation Capacitance <sup>(5)</sup> (per Package) |              | 136                |                   |             |                | pF    |
| $C_{IN}$           | Maximum Input Capacitance                                  |              | 5                  | 10                | 10          | 10             | pF    |

**Note:**

5.  $C_{PD}$  determines the no-load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no-load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

AC Waveforms

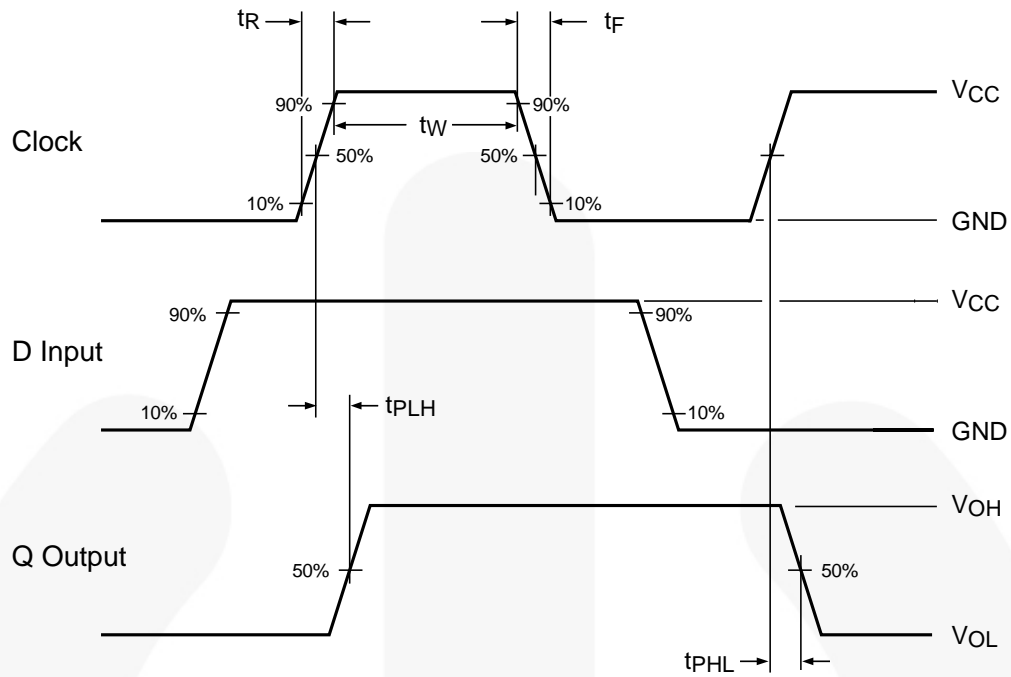


Figure 3. AC Waveform

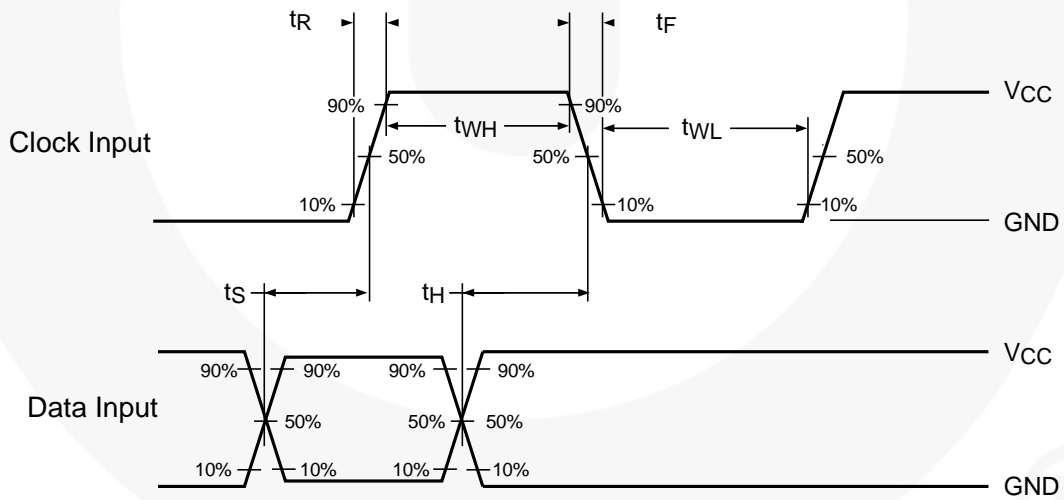


Figure 4. AC Waveform

Physical Dimensions

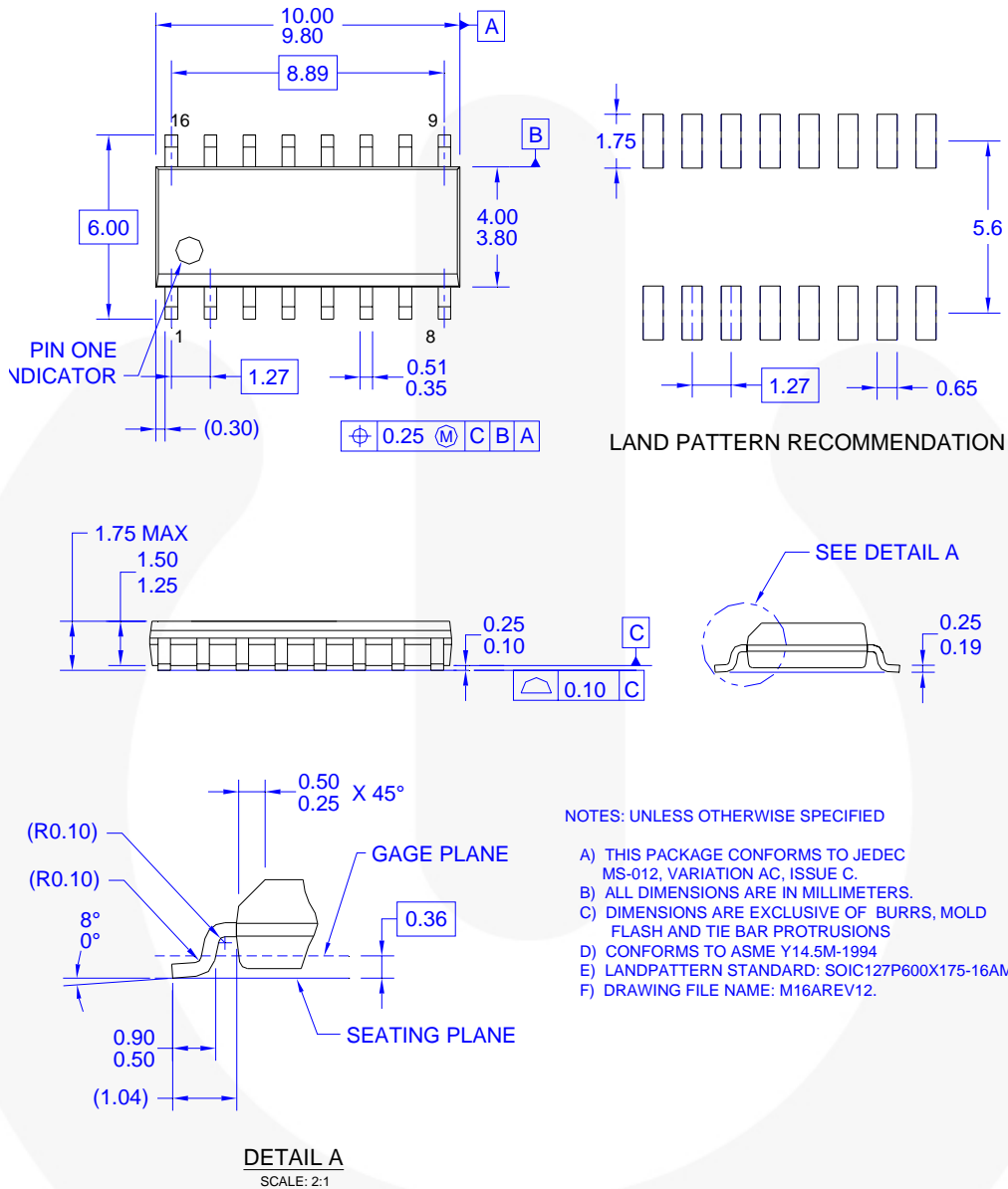
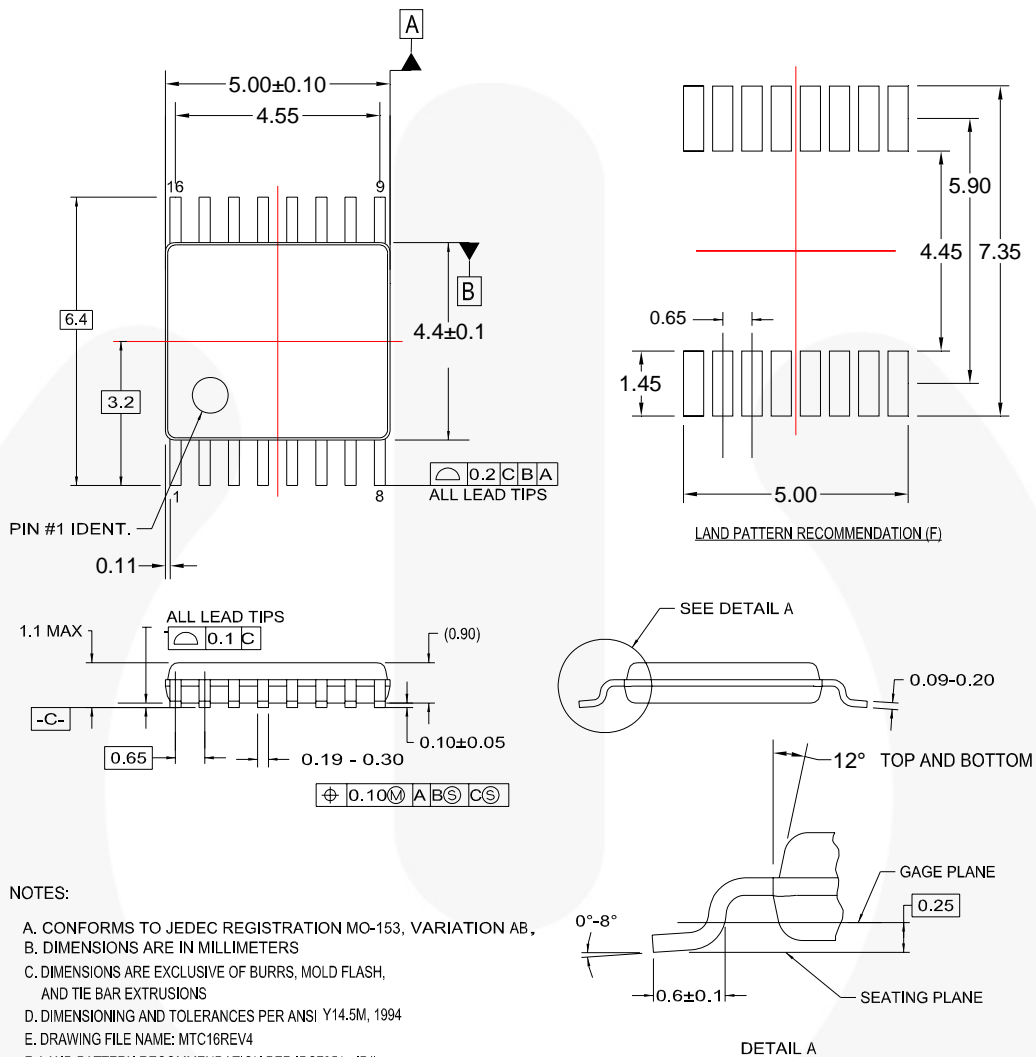


Figure 5. 16-Lead, Small Outline Integrated Circuit (SOIC)

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## Physical Dimensions



MTC16rev4

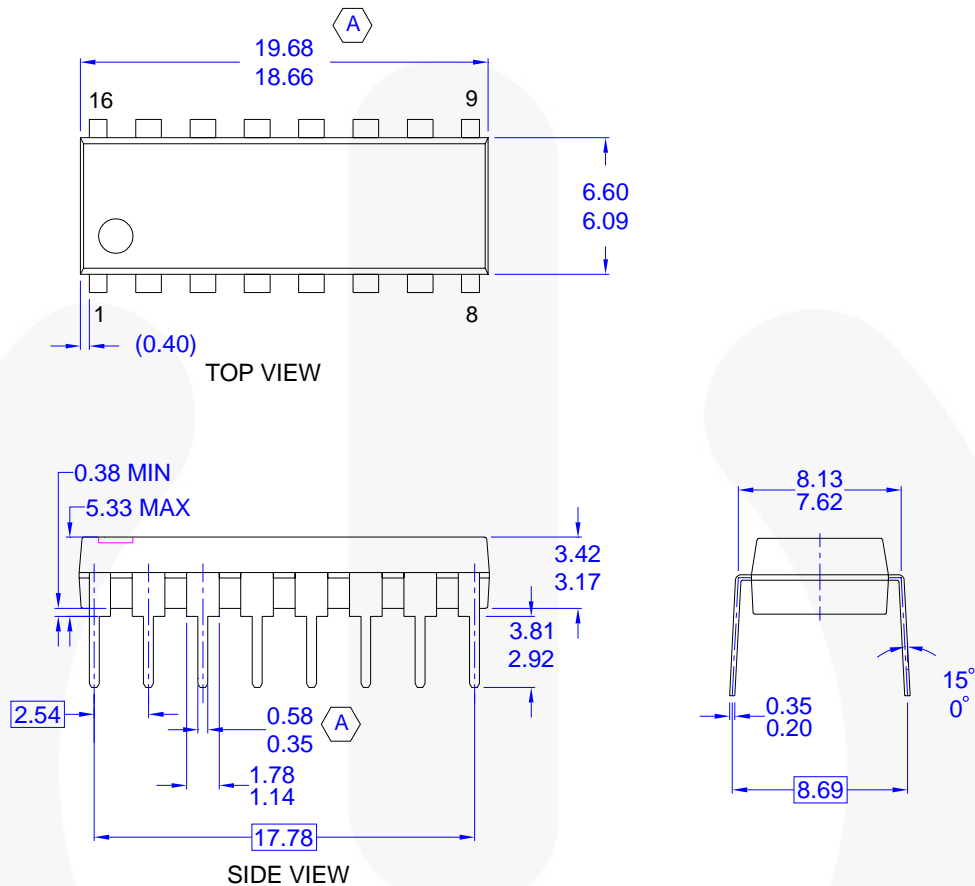
**Figure 6. 16-Lead Thin Shrink Small Outline Package (TSSOP)**

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- D) CONFORMS TO ASME Y14.5M-1994
- E) DRAWING FILE NAME: N16EREV1

**Figure 7. 16-Lead Plastic Dual-In-Line Package (PDIP)**







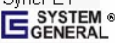
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